

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 5478

Hidenori HASEGAWA

Attorney Docket No. 2004 0096A

Serial No. 10/762,451

Group Art Unit 2823

Filed January 23, 2004

Examiner Fernando Toledo

SEMICONDUCTOR DEVICE AND FABRICATION METHOD THEREOF

RESPONSE UNDER 37. OFR 1.116

Expedited procedure

EXAMINING GROUP 2823

REQUEST FOR RECONSIDERATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In view of the following remarks, reconsideration of the rejections contained in the Office Action of March 20, 2006 is respectfully requested.

Claims 8-17, including independent claims 8, 11, and 14, are presently pending and were treated in the outstanding Office Action. In particular, the Examiner rejected all the pending claims as being anticipated by the Minamio reference (US Application Publication 2003/0015775). In other words, the Examiner applied the same prior art reference applied in the previous Office Action of July 26, 2005. However, the Examiner's rejections are traversed. For the reasons discussed below, it is respectfully submitted that claims 8-17 are clearly patentable over the prior art of record.

In a conventional semiconductor device, a leadframe needs to be prepared with a particular shape so as to match a specific semiconductor chip. At least partly due to this inconvenience, such a semiconductor device cannot be manufactured using an efficient sequence of processing steps. As a result, the necessary time required to fabricate the semiconductor device is increased (see page 2, lines 4-17 of the original specification).